STYLE 1: PIN 1. BASE

STYLE 5: PIN 1. GATE 2. ANODE

2. COLLECTOR 3. EMITTER

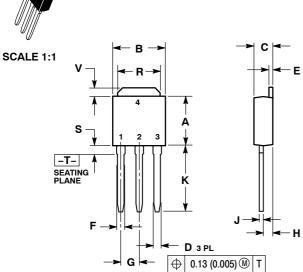
4. COLLECTOR

3. CATHODE

4. ANODE



DATE 15 DEC 2010



STYLE 2: PIN 1. GATE

STYLE 6: PIN 1. MT1 2. MT2 3. GATE

4. MT2

DRAIN
 SOURCE

4. DRAIN

STYLE 3: PIN 1. ANODE

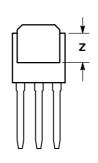
2. CATHODE 3. ANODE

4. CATHODE

STYLE 7: PIN 1. GATE 2. COLLECTOR

3. EMITTER

4. COLLECTOR



NOTES:

- DIMENSIONING AND TOLERANCING PER
- ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.

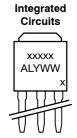
	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.235	0.245	5.97	6.35
В	0.250	0.265	6.35	6.73
С	0.086	0.094	2.19	2.38
D	0.027	0.035	0.69	0.88
E	0.018	0.023	0.46	0.58
F	0.037	0.045	0.94	1.14
G	0.090 BSC 2.29 BSC		BSC	
Н	0.034	0.040	0.87	1.01
J	0.018	0.023	0.46	0.58
K	0.350	0.380	8.89	9.65
R	0.180	0.215	4.45	5.45
S	0.025	0.040	0.63	1.01
V	0.035	0.050	0.89	1.27
z	0.155		3.93	

MARKING DIAGRAMS

STYLE 4: PIN 1. CATHODE 2. ANODE 3. GATE

4. ANODE

Discrete YWW XXXXXXX



xxxxxxxxx = Device Code Α = Assembly Location = Wafer Lot IL

Υ = Year WW = Work Week

DESCRIPTION:	IPAK (DPAK INSERTION MOUNT)		PAGE 1 OF 2	
NEW STANDARD:	REF TO JEDEC TO-251	"CONTROLLED COPY" in red.		
STATUS:	ON SEMICONDUCTOR STANDARD	accessed directly from the Document versions are uncontrolled except		
DOCUMENT NUMBER:	98AON10528D	Electronic versions are uncontrolled	•	



DOCUMENT NUMBER: 98AON10528D

PAGE 2 OF 2

ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION. REQ. BY L. GAN	24 SEP 2001
A	CHANGED STANDARD TO TO-251, WAS TO-252. REQ. BY J. BECHTOLD	24 NOV 2003
В	REMOVED FOOTPRINT. REQ. BY J. LESLIE	03 DEC 2003
С	CHANGED DESCRIPTION TO IPAK. REQ. BY J. JEONG.	15 DEC 2010

ON Semiconductor and a registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.